

General Information

The VES0123R0T3 protects sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD) and other voltage induced transient events. They feature large crosssectional area junctions for conducting high transient currents, offer desirable electrical characteristics for board level protection, such as fast response time, low operating voltage. It gives designer the flexibility to protect one bi-directional line in applications where arrays are not practical.

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Maximum Contact discharge voltage Per IEC61000-4-2		8KV	V
Maximum Air discharge voltage Per IEC61000-4-2		15KV	V
Maximum Operating temperature	T _{OPER}	-40 to +90	ĉ
Maximum Storage temperature	T _{STG}	-55 to +125	ĉ
Maximum lead temperature for soldering during 10s	Τ _L	260	°C

Electrical Characteristics (@ T_A = 25 °C Unless Otherwise Noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Working voltage	V _{DC}	< 1 µA			12	V
Varistor voltage	Vv	measured at 1 mA current	26			V
Clamping voltage	V _c	8/20us waveform and 1A pulse current			48	V
Leakage current	I_L	measured at working voltage			1.00	uA
Junction Capacitance	C _P	V _R =0V,f=1MHz; Any I/O pin to GND		3		pF



VES0123R0T3 ----- ESD Protection Devices

Product Dimensions



Dimension	0201(0603)
L	$\frac{0.6\pm0.03}{(0.02\pm0.001)}$
W	$\frac{0.3\pm0.03}{(0.01\pm0.001)}$
т	$\frac{0.3\pm0.03}{(0.01\pm0.001)}$
С	$\frac{0.15\pm0.03}{(0.006\pm0.001)}$

DIMENSIONS:

Recommended PCB Footprint



Dimension	0201(0603)
А	<u>0.25-0.35</u> (0.020)
В	<u>0.25-0.35</u> (0.020)
С	<u>0.25-0.35</u> (0.024)

DIMENSIONS: <u>MM</u> (INCHES)

Construction

Dimension







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Recommendable reflow soldering

Profile Feature	Pb-Free Assembly
Average Ramp-UP Rate	3 ℃/secondmax.
(Tsmax to Tp)	
Preheat	
-Temperature Min(Tsmin)	150 ℃
-Temperature Max(Tsmax)	200 °C
-Time(Tsmin to Tsmax)	60-180seconds
Time maintained above:	
-Temperature(TL)	217 °C
-Time(tL)	60-150 seconds
Peak/Classification Temperature(Tp)	260°C
Time within 5°CofactualPeak	20-40 seconds
Temperature(tp)	
Ramp-Down Rate	6℃/secondmax.
Time 25℃toPeakTemperature	8 minutes max.





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Packaging Information

Symbol	0201(0603)
А	$\begin{array}{c} \underline{0.36 \pm 0.03} \\ (0.0142 \pm 0.001) \end{array}$
В	$\begin{array}{c} \underline{0.07 \pm 0.03} \\ (0.003 \pm 0.001) \end{array}$
Е	$\frac{1.75\pm0.10}{(0.069\pm0.004)}$
F	<u>3.5±0.05</u> (0.138±0.002)
PO	$\frac{4.00\pm0.10}{(0.157\pm0.004)}$
P1	<u>2.00±0.05</u> (0.079±0.002)
P2	<u>2.00±0.05</u> (0.079±0.002)
D0	$\frac{1.50\pm0.10}{(0.059\pm0.004)}$
W	$\frac{8.00\pm0.30}{(0.315\pm0.012)}$
т	$\frac{0.42 \pm 0.03}{(0.0165 \pm 0.001)}$
D1	<u>21.00±0.80</u> (0.827±0.032)
Н	<u>180.00±2.00</u> (7.087±0.079)
H1	<u>62.0±1.5</u> (2.44±0.059)
H2	$\frac{13.00\pm1.00}{(0.512\pm0.039)}$
W1	$\frac{13.0\pm1.00}{(0.512\pm0.039)}$



Quantity of products in the taping package

- (1) Standard quantity : 15000pcs/Reel for the Series.
- (2) Shipping quantity is a multiple of standard quantity.
- (3) For more information, please contact our local agents.